

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1294	257/664,659.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/10 14:38
L2	889	257/660-663.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/10 14:42
L3	1905	438/112,124,127.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/10 14:42
S1	868	257/659.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/01/10 14:31
S2	435	257/664.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/13 09:51
S3	19	electromagnetic adj1 interference	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/13 09:53
S4	3077	EMI adj1 shielding	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/13 09:53
S5	435	(EMI adj1 shielding) and semiconductor	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/13 09:54
S6	238	((EMI adj1 shielding) and semiconductor) and substrate	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/13 09:54

S7	3077	emi adj1 shielding	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/13 10:22
S8	18	(emi adj1 shielding) and MEMS	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/13 10:24
S9	180	EMI and MEMS	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/13 10:27
S10	412	(emi adj1 shielding) and interconnect	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/13 10:28
S11	13	(("4626889") or ("4673904") or ("5288949") or ("5309015") or ("5338897") or ("5357138") or ("5729047") or ("5811882") or ("4866507") or ("4908694") or ("5135889") or ("5241211") or ("5262353") or ("5357138")).PN.	USPAT; USOCR	OR	OFF	2004/10/14 09:04
S12	11	((("5811882") or ("4776087") or ("5136357") or ("4626889") or ("5491352") or ("6043558") or ("5357138") or ("4673904") or ("6133621") or ("4776087") or ("4845311") or ("5729047")).PN.	USPAT; USOCR	OR	OFF	2004/10/14 09:08
S13	876	257/660-663.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/14 10:07
S14	29	257/660-663.ccls. and EMI	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/14 09:09
S15	14	438/112,124,127.ccls. and EMI	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/14 10:08
S16	1	LYDEGRAF-CURT-VAN	USPAT	OR	OFF	2004/10/14 10:09
S17	5	LYDEGRAF-CURT-VAN	US-PGPUB; USPAT	OR	OFF	2004/10/14 10:09

S18	1841	438/112,124,127.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/14 10:11
S19	51564	interconnect and substrate	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/18 05:31
S20	881	(interconnect and substrate) and EMI	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/18 05:46
S21	2793	MEMS and electromagnetic	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/18 05:46
S22	201	MEMS and electromagnetic adj1 interference	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/18 05:54
S23	1770	MEMS and interconnect	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/18 05:55